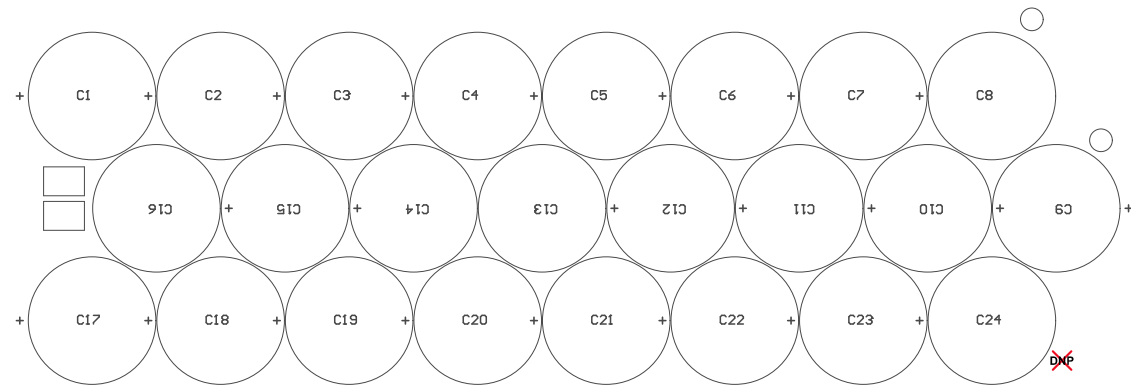


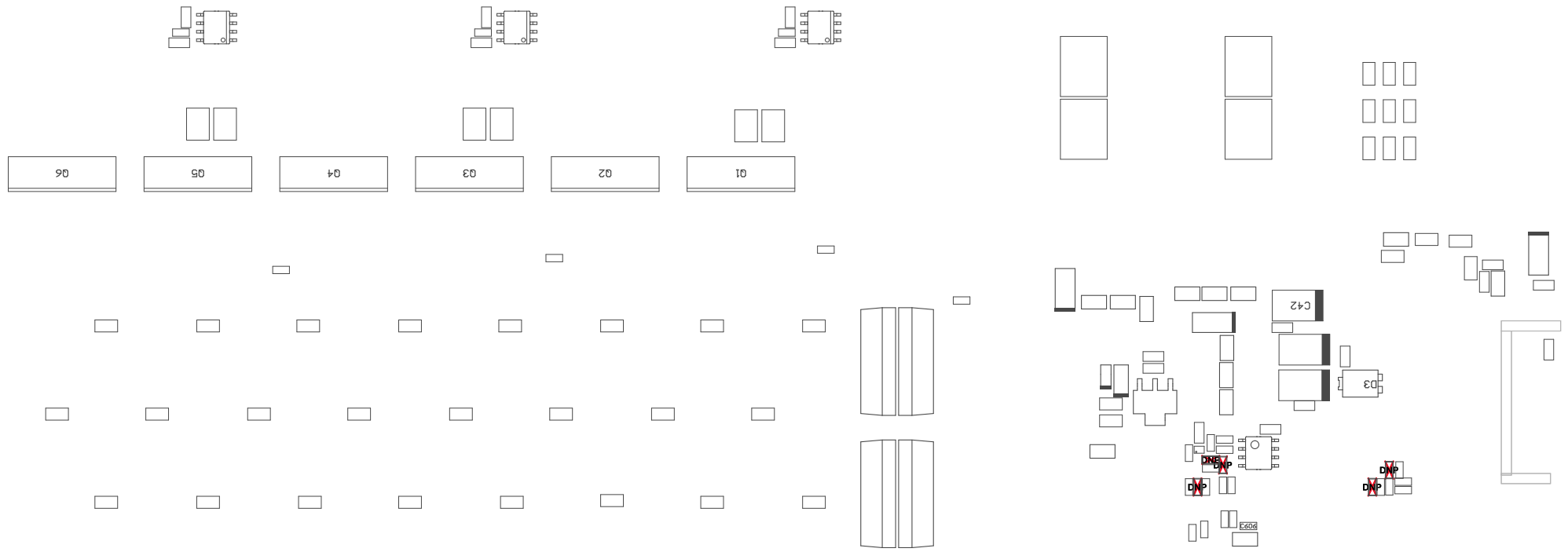
~~DNP~~ ~~DNP~~



~~DNP~~

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-01604	REV: E2	SVN REV: Not In VersionControl
	TID #: TIDA-01604		
PLOT NAME = Top Assembly Drawing	GENERATED : 2/28/2018	1:37:55 PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-01604	REV: E2	SUN REV: Not In VersionControl
	TID #: TIDA-01604		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 2/28/2018	1:37:57 PM	TEXAS INSTRUMENTS

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